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BGO807; BGO807/FC0; BGO807/SC0

870 MHz optical receivers

Rev. 2 — 29 September 2010

Product data sheet

1. Product profile

1.1 General description

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fiber has either no connector or has an FC/APC or SC/APC connector.

The amplifier supply voltage pin and the photo diode bias voltage pin both connect to 24 V (DC).

The modules have a mono mode optical input suitable for 1290 nm to 1600 nm wavelengths, a terminal to monitor the photo diode current and an electrical output having a characteristic impedance of 75 Ω .

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Low noise
- Excellent flatness
- Standard CATV outline
- Rugged construction
- Gold metallization ensures excellent reliability
- High optical input power range.

1.3 Applications

• CATV optical node systems operating in the 40 MHz to 870 MHz frequency range.



870 MHz optical receivers

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f	frequency range		40	-	870	MHz
S ₂₂	output return losses	f = 40 MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB
d ₂	second order distortion	f = 854.5 MHz	-	-	-55	dB
F	equivalent noise input	f = 40 MHz to 870 MHz	-	-	8.5	pA/√Hz
I _{tot}	total current consumption (DC)	V _B = 24 V	175	-	205	mA

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
BGO807	(SOT115T)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		9
5	$+V_B$ of the amplifier		✐╡
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BGO807/	FC0 (SOT115X)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		✐╡
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BGO807/	SC0 (SOT115Y)		
1	monitor current		
2, 3	common		
4	$+V_B$ of the photodiode		
5	$+V_B$ of the amplifier		✐╡
7, 8	common		1 2, 3, 7, 8
9	output		1 2, 3, 7, 8 sym098

3. Ordering information

Table 3.	Ordering information
----------	----------------------

Type number	Package					
	Name	Description	Version			
BGO807	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads	SOT115T			
BGO807/FC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115X			
BGO807/SC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115Y			

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
f	frequency range		40	870	MHz
T _{stg}	storage temperature		-40	+85	°C
T _{mb}	operating mounting base temperature		-20	+85	°C
P _{in}	optical input power	continuous	-	5	mW
ESD	ESD sensitivity	human body model; R = 1.5 k Ω ; C = 100 pF	500	-	V

5. Characteristics

Table 5.Characteristics

In accordance with the Absolute Maximum Rating System (IEC 60134); bandwidth 40 MHz to 870 MHz; $V_B = 24 V$; $T_{mb} = 30 \ ^{\circ}C$; $Z_L = 75 \Omega$.

	-						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
S	responsivity						
	BGO807	$\lambda = 1300 \text{ nm}$		800	-	-	V/W
	BGO807/FC0; BGO807/SC0	λ = 1300 nm		750	-	-	V/W
FL	flatness straight line (peak to valley)	f = 40 MHz to 870 MHz		-	-	1	dB
SL	slope straight line	f = 40 MHz to 870 MHz		0	-	2	dB
S ₂₂	output return losses	f = 40 MHz to 870 MHz		11	-	-	dB
	optical input return losses			45	-	-	dB
d ₂	second order distortion	f _m = 446.5 MHz	[1][2]	-	-	-66	dB
		f _m = 746.5 MHz	[1][3]	-	-	-61	dB
		f _m = 854.5 MHz	[1][4]	-	-	-55	dB
d ₃	third order distortion	f _m = 853.25 MHz	[5][6]	-	-	-71	dB

|--|

BGO807_FC0_SC0

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Table 5. Characteristics ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134); bandwidth 40 MHz to 870 MHz; $V_B = 24 V$; $T_{mb} = 30 \ ^{\circ}C$; $Z_L = 75 \Omega$.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
F	equivalent noise input	f = 40 MHz to 450 MHz	-	-	7	pA/√Hz
		f = 450 MHz to 750 MHz	-	-	8	pA/√Hz
		f = 750 MHz to 870 MHz	-	-	8.5	pA/√Hz
s_{λ}	spectral sensitivity	$\lambda = 1310 \pm 20 \text{ nm}$	0.85	-	-	A/W
		$\lambda = 1550 \pm 20 \text{ nm}$	0.9	-	-	A/W
λ	optical wavelength		1290	-	1600	nm
L	length of optical fiber; SM type; 9/125 μm					
	BGO807		1	-	-	m
	BGO807/FC0; BGO807/SC0		746	-	861	mm
I _{tot}	total current consumption (DC)		175	-	205	mA
I _{bias}	diode bias current at pin 4 (DC)		-	-	25	mA

[1] Two laser test; each laser with a modulation index of 40%; $P_{opt} = 1 \text{ mW}$ (total).

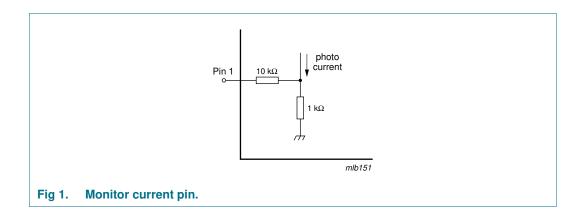
[2] $f_m = 446.5 \text{ MHz}$; $f_p = 97.25 \text{ MHz}$; $f_q = 349.25 \text{ MHz}$.

 $[3] \quad f_m = 746.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 613.25 \text{ MHz}.$

[4] $f_m = 854.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 721.25 \text{ MHz}.$

[5] Three laser test; each laser with a modulation index of 60%; P_{opt} = 1 mW (total).

[6] $f_m = 853.25 \text{ MHz}$; $f_p = 133.25 \text{ MHz}$; $f_q = 265.25 \text{ MHz}$; $f_r = 721.25 \text{ MHz}$.

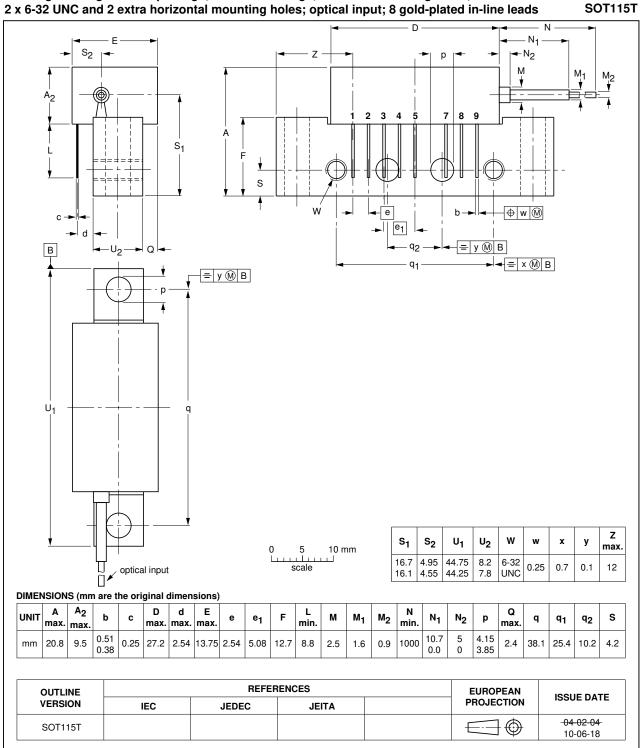


NXP Semiconductors

BG0807/BG0807/FC0/SC0

870 MHz optical receivers

Package outline 6.



Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads

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Product data sheet

BGO807 FC0 SC0

Package outline SOT115T. Fig 2.

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SOT115X

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

N₁ Е D S₂ Ζ N_2 р М M₁ ¥ A₂ 7 2 8 9 3 4 S₁ Т s 4 с 🗕 w 0 w е h → d e₁ Q Up В - = y M B q2 = y 🕅 B q1 р N R Uı a 25 mm Scale connector 10 mm z 5 0 s₁ s₂ U₁ s w U2 w х У тŤт max Т scale 16.7 4.95 44.75 8.2 6-32 4.2 0.25 Ũ 0.7 0.1 12 16.1 4.55 44.25 7.8 UNC DIMENSIONS (mm are the original dimensions) D Е R Α Α2 d L Q M₂ UNIT F b с e₁ Μ Μ1 Ν е N₁ N_2 р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 12.7 8.8 2.5 1.6 0.9 2.4 38.1 25.4 10.2 35 mm 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-04 \bigcirc SOT115X ----10-06-18

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Product data sheet

BGO807_FC0_SC0

Fig 3. Package outline SOT115X.

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SOT115Y

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

N₁ Е D S₂ Ζ N_2 р М M₁ M₂ ¥ A₂ 7 2 8 9 3 4 S₁ Т s 4 с 🗕 w 0 w е h → d e₁ U₂ Q В q2 = y 🕅 B q1 р R Uı a 0 25 mm Scale connector z 10 mm 5 s₁ 0 s S_2 w U1 U2 w x у max ъŤ. L Π scale 44.75 8.2 7.8 6-32 UNC 16.7 4.95 4.2 0.25 0.7 0.1 12 Ũ 4.55 44.25 16.1 DIMENSIONS (mm are the original dimensions) D Е R Α Α2 d L Q M₂ N₁ UNIT F b с М Μ1 Ν N_2 е e₁ р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 12.7 8.8 2.5 1.6 0.9 2.4 38.1 25.4 10.2 35 mm 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-05 \odot SOT115Y **F**·· 10-06-18

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Product data sheet

BGO807 FC0 SC0

Fig 4. Package outline SOT115Y.

7. Handling information

Fiberglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

8. Revision history

Table 6. Revision histor	ry			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BGO807_FC0_SC0 v.2	20100929	Product data sheet	-	BGO807_FC0_SC0 v.1
Modifications:		f this data sheet has bee NXP Semiconductors.	n redesigned to comply	with the new identity
	 Legal texts h 	ave been adapted to the	new company name w	here appropriate.
	 Pinning infor 	mation: presentation was	modified, graphic sym	bols were added.
	 Package out 	line and simplified outline	drawings have been u	pdated to the latest version.
BGO807_FC0_SC0 v.1 (9397 750 13192)	20040707	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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